Hong Kong Exchanges and Clearing Limited and The Stock Exchange of Hong Kong Limited take no responsibility for the contents of this announcement, make no representation as to its accuracy or completeness and expressly disclaim any liability whatsoever for any loss howsoever arising from or in reliance upon the whole or any part of the contents of this announcement.



中興通訊股份有限公司

(a joint stock limited company incorporated in the People's Republic of China with limited liability)

(Stock Code: 763)

Overseas Regulatory Announcement Announcement on the Information of the Issuance of 2022 Tranche XV to Tranche XIX Super and Short-term Commercial Paper

This announcement is made pursuant to Rule 13.10B of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited.

The Company and all the members of the Board of Directors confirm that all the information contained in this information disclosure is true, accurate and complete and that there is no false and misleading statement or material omission in this information disclosure.

ZTE Corporation (the "Company") has received the "Notice of Admission for Registration" (Zhong Shi Xie Zhu [2021] No. DFI30) (《接受註冊通知書》(中市協注〔2021〕DFI30 號)) (the "Notice") issued by the National Association of Financial Market Institutional Investors (中國銀行間市場交易商協會) agreeing to accept the registration of the Company's debt financing instruments, which is valid for a period of 2 years from the date of the Notice. During the effective term of registration, the Company may issue super short-term commercial paper (the "SCP"), short-term commercial paper, medium-term note, perpetual note and asset-backed note in different tranches, may also targeted issue related products. For details, please refer to the relevant announcement published by the Company on 18 August 2021.

On 8 April 2022, the Company completed the issuance of 2022 Tranche XV to Tranche XIX SCP at the nominal value.

Bond name	Amount		Nominal Accrual		rual	Maturity		Term	Interest	Lead Underwriter	
	of		Value	Date		Date			Rate		
	Issuance										
2022 Tranche	RMB	1	RMB 100	8	April	30	June	83 days	2.20%	Lead Unde	rwriter: China
XV SCPs	billion	billion		2022		2022				Everbright Bank Co., Ltd	
										Joint Lead	Underwriter:
					Industrial		Industrial B	ank Co., Ltd.			
2022 Tranche	RMB	1	RMB 100	8	April	30	June	83 days	2.20%	Lead	Underwriter:

XVI SCPs	billion			2022	2	2022				Shanghai	Pudo	ong
										Developmen	t Bank C	Со.,
										Ltd.		
										Joint Lead	Underwri	ter:
										Bank of Co	mmunicati	ons
										Co., Ltd.		
Tranche XVII	RMB	1	RMB 100	8	April	30	June	83 days	2.20%	Lead Under	rwriter: P	ing
SCPs	billion			2022	2	2022				An Bank Co., Ltd.		
										Joint Lead	Underwri	ter:
										Hua Xia Ban	k Co., Ltd.	
2022 Tranche	RMB	1	RMB 100	8	April	30	June	83 days	2.20%	Bank of Chir	na Co., Ltd	
XVIII SCPs	billion			2022	2	2022						
2022 Tranche	RMB	1	RMB 100	8	April	30	June	83 days	2.20%	Lead Under	writer: Ch	ina
XIX SCPs	billion			2022	2	2022				Guangfa Bank Co., Ltd.		
										Joint Lead	Underwri	ter:
										Agricultural	Bank	Of
										China Co., L	td.	

Proceeds raised through 2022 Tranche XV to Tranche XIX SCP were received in full on 8 April 2022 and will be applied to supplement working capital, repay loans and acceptance bill.

For details of documents pertaining to the issuance of 2022 Tranche XV to Tranche XIX SCP, please refer to the Company's announcement published on the website of Shanghai Clearing House (www.shclearing.com) and chinamoney.com (www.chinamoney.com.cn).

The total amount of SCP (including the 2022 Tranche XV to Tranche XIX SCP) issued by the Company but not due as at the date of 8 April 2022 is RMB 10 billion.

By Order of the Board **Li Zixue** *Chairman*

Shenzhen, the PRC 8 April 2022

As at the date of this announcement, the Board of Directors of the Company comprises three executive directors, Li Zixue, Xu Ziyang, Gu Junying; three non-executive directors, Li Buqing, Zhu Weimin, Fang Rong; and three independent non-executive directors, Cai Manli, Gordon Ng, Zhuang Jiansheng.